

SERDESUB-16USB User's Guide

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Introduction:

Texas Instruments' Automotive Serdes DS90UB901Q/902Q FPD-Link III evaluation kit contains one (1) DS90UB901Q Serializer board, one (1) DS90UB902Q Deserializer board, and one (1) two (2) meter* high speed USB 2.0 cable. *Note: the chipset can support up to ten (10) meters.

The DS90UB901Q/902Q chipset supports a variety of automotive vision applications over a two (2) wire serial stream. The single differential pair (FPD-Link III) is well-suited for direct connections between camera systems and Host Controller/Electronic Control Unit (ECU)/FPGA. The bidirectional control channel of the DS90UB901Q/902Q provides seamless communication between the image sensor and ECU/FPGA. Other typical automotive vision systems may include: rear view, side view camera, lane departure warning, parking assistance, blind spot view, etc.

This kit will demonstrate the functionality and operation of the DS90UB901Q and DS90UB902Q chipset. The chipset enables transmission of a high-speed video data along with a low latency bi-directional control bus over a single twisted pair cable. The integrated control channel transfers data bi-directionally over the same serial video link. The transport delivers 16 bits of parallel data together with bidirectional control channel that supports an I2C bus. Additionally, there are six user-configurable GPIO (General Purpose IO) for sending control data. This interface allows transparent full-duplex communication over a single high-speed differential pair, carrying asymmetrical bi-directional control information without the dependency of video blanking intervals. The Serializer and Deserializer chipset is designed to transmit data at PCLK clocks speeds ranging from 10 to 43 MHz and I2C bus rates up to 100 kbps at up to 10 meters cable length over -40 to +105 Deg C.

The Serializer board accepts 1.8V/3.3V parallel input signals. FPD-Link III Serializer converts the 1.8V/3.3V LVCMOS parallel lines into a single serialized data pair with an embedded clock. The serial data line rate switches at 28 times the base clock frequency. With an input clock at 43 MHz, the transmission line rate for the FPD-Link III is 1.20Gbps (28 x 43MHz).

The user needs to provide the proper 1.8V/3.3V LVCMOS inputs and 1.8V/3.3V LVCMOS clock to the Serializer and also provide a proper interface from the Deserializer output to test equipment. The Serializer and Deserializer boards can also be used to evaluate device parameters. A cable conversion board or harness scramble may be necessary depending on type of cable/connector interface used on the input to the DS90UB901Q and to the output of the DS90UB902Q.

The demo boards are not intended for EMI testing. The demo boards were designed for easy accessibility to device pins with tap points for monitoring or applying signals, additional pads for termination, and multiple connector options.



System Requirements:

In order to demonstrate, the following are required:

- 1) Video source with 1.8V or 3.3V LVCMOS parallel interface
- 2) Microcontroller (MCU) or FPGA with I2C interface bus (I2C master)
 - a. slave clock stretching must be supported by the I2C master controller/MCU.
- 3) External peripheral device that supports I²C (slave mode)
- 4) Power supply for 1.8V (required) and 3.3V (optional)

Contents of the Demo Evaluation Kit:

- 1) One Serializer board with the DS90UB901Q
- 2) One Deserializer board with the DS90UB902Q
- 3) One 2-meter high speed USB 2.0 cable (4-pin USB A to 5-pin mini USB)
- 4) Evaluation Kit Documentation (this manual)
- 5) DS90UB901Q/902Q Datasheet

DS90UB901Q/902Q Serdes Typical Application:

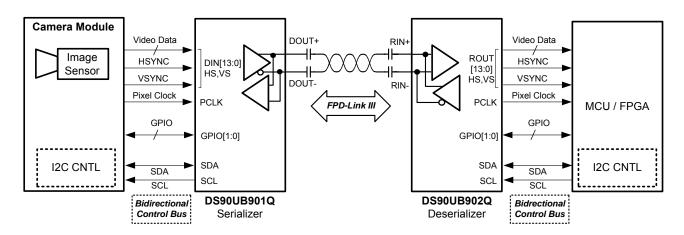


Figure 1. Typical Application

The diagram above illustrates a typical application of DS90UB901Q/902Q chipset. The MCU/FPGA can program device registers on the DS90UB901Q, DS90UB902Q, and remote peripheral device, such as a camera.



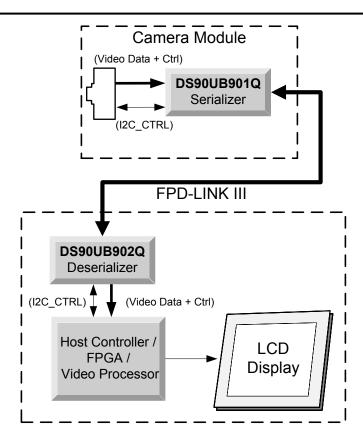


Figure 2. Typical DS90UB901Q/902Q Camera System Diagram

Figure 1 and **Figure 2** illustrate the use of the Chipset (Serializer/Deserializer) in a Camera to Host (MCU/FPGA) Controller.

Refer to the proper datasheet information on Chipsets (Serializer/Deserializer) provided on each board for more detailed information.



How to set up the Demo Evaluation Kit:

The DS90UB901Q/902Q evaluation boards consist of two sections. The first part of the board provides the point-to-point interface for transmitting parallel video data. The second part of the board allows bi-directional control communication of an I²C bus control of using a MCU/FPGA to programming a remote peripheral device via the Deserailizer.

The PCB routing for the Serializer input pins (DIN) accept incoming parallel video data at 1.8V/3.3V LVCMOS signals from J1 IDC connector. The FPD-Link III interface uses a single twisted pair cable (provided). The output pins (ROUT) are accessed through a J7 IDC connector. Please follow these steps to set up the evaluation kit for bench testing and performance measurements:

1)	A two (2) meter high speed USB 2.0 cable has been included in the kit. Connect the 4-
	pin USB A side of cable harness to the serializer board and the other
	side of the harness, the 5-pin mini USB jack [123.4] MINI to the Deserializer board.
	This completes the FPD-Link III interface connection.
	NOTE: The DS9UB901Q and DS9UB902Q are NOT USB compliant and should
	not be plugged into a USB device nor should a USB device be plugged into the
	demo boards.

- 2) Jumpers and switches have been configured at the factory; they should not require any changes for immediate operation of the chipset. See text on Configuration settings and datasheet for more details.
- 3) From the video source, connect a flat cable (not supplied) to the Serializer board and connect another flat cable (not supplied) from the Deserializer board to the controller. Note: For 50 ohm signal sources, provide 1.8V/3.3V LVCMOS input signal levels into DIN[13:0],HS,VS and PCLK and add 50 ohm parallel termination resistors R3-R19 on the DS9UB901Q Serializer board.
- 4) Connect the Serializer I²C ports to the I²C of the peripheral slave device. Connect the Deserializer I²C ports to the I²C bus of the MCU/FPGA (I²C master).
- 5) Power for the Serializer and Deserializer boards must be supplied externally through Power Jack (VDD). Grounds for both boards are connected through Power Jack (VSS) (see section below).



Bi-Directional Control Bus And I2C Modes:

In order to communicate and synchronize with remote devices on the I²C bus through the bi-directional control channel, slave clock stretching must be supported by the I²C master controller/MCU. The chipset utilizes bus clock stretching (holding the SCL line low) during data transmission; where the I²C slave pulls the SCL line low prior to the 9th clock of every I²C data transfer (before the ACK signal).

The bidirectional control bus supports is a I²C compatible interface that allows programming of the DS90UB901Q, DS90UB902Q, or an external remote device (such as a camera or display). Register programming transactions to/from the DS90UB901Q/902Q chipset are employed through the clock (SCL) and data (SDA) lines. These two signals have open drain I/Os and must be pulled-up to VDDIO by external resistors. The boards have an option to use the on-board 1.0K Ω pull-up resistors tied to VDDIO or connected through external pull-ups at the target Host. The appropriate pull-up resistor values will depend upon the total bus capacitance and operating speed. The DS90UB901Q/902Q I²C bus data rate supports up to 100 kbps according to I²C specification.

To start any data transfer, the DS90UB901Q/902Q must be configured in the proper I²C mode. Each device can function as an I²C slave proxy or master proxy depending on the mode determined by MODE (M_S) pin. Note the MODE pin is label as M_S on the PCB boards. The Ser/Des interface acts as a virtual bridge between Master controller (MCU) and the remote device. When the MODE (M_S) pin is set to High, the device is treated as a slave proxy; acts as a slave on behalf of the remote slave. When addressing a remote peripheral or Serializer/Deserializer (not wired directly to the MCU), the slave proxy will forward any byte transactions sent by the Master controller to the target device. When MODE (M_S) pin is set to Low, the device will function as a master proxy device; acts as a master on behalf of the I²C master controller. Note that the devices must have complementary settings for the MODE configuration. For example, if the Serializer MODE (M_S) pin is set to High then the Deserializer MODE (M_S) pin must be set to Low and vice-versa.

Demo Board Power Connections:

The Serializer and Deserializer boards must be powered by supplying power externally through J3 (VDD) and J4 (VSS) on Serializer Board and J4 (VDD) and J5 (VSS) on Deserializer board. Note +2.5V is the MAXIMUM voltage that should ever be applied to the Serializer J3 or Deserializer J4 VDD terminal. Serializer JP1 VDDI and Deserializer VDDIO JP1 must never exceed +4.0V. Damage to the device(s) can result if the voltage maximum is exceeded.

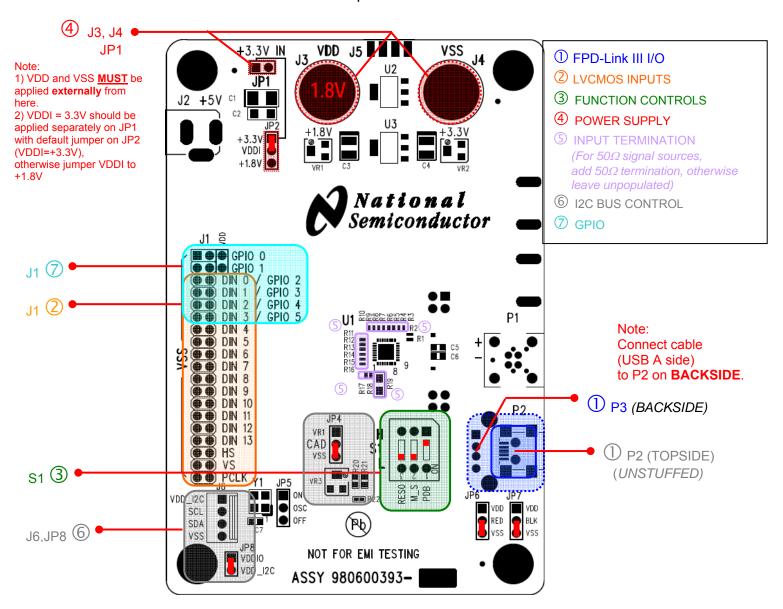


DS9UB901Q Serializer Board Description:

The 2x17-pin IDC connector J1 accepts 16 bits of 1.8V or 3.3V data along with the PCLK clock input. VDDI must be set externally for 1.8V or 3.3V LVCMOS inputs.

The Serializer board is powered externally from the J3 (VDD) and J4 (VSS) connectors shown below. For the Serializer to be operational, the S1-PDB switch on S1 must be set HIGH. S1-RES0 must be set LOW. Master or slave mode is user selected on S1-M_S (MODE); please refer to DS90UB901/902 datasheet for details.

The USB connector P3 (USB-A side) on the bottom side of the board provides the interface connection to the Deserializer board. Note: P2 (mini USB) on the top side is unstuffed and not to be used with the cable provided in the kit.





Configuration Settings for the Serializer Demo Board

VDDI: 1.8V or 3.3V LVCMOS INPUT/OUTPUT SELECTION

Reference	Description	+1.8V VDDI	+3.3V VDDI	JP2
JP2	VDDI LVCMOS	VDDI = 1.8V	VDDI = 3.3V	
	I/O level configuration.		(Default)	
		JP1 JP2 1.8V JP1 JP2 +3.3V JD0 JP2 +1.8V JD0 JP2 +1.8V JD0 JP2 +1.8V JD0 JP2 JD0 JP2 JD0 JP2 JD0 JP2 JD0 JP2 JD0	43.3V IN J3 VDD IN J3 VDD IN JP2 IN J	+3.3V IN J3 VDD JP1 +3.3V IN JP2 +3.3V IN JBP2 +3.4V IN JP2 +3.4V IN
			apply external	
		1.8V	3.3V	
		LVCMOS	LVCMOS	
		inputs	inputs	

S1: Serializer Input Features Selection

Reference	Description	Input = L	Input = H		S 1
M_S (MODE)	I2C Master / Slave select	Master (Default)	Slave	н	••■
PDB	PowerDown Bar	Powers Down	Operational (Default)	S1	
RES 0 (* IMPORTANT See user note below)	Reserved	MUST be tied low for normal operation (Default)		L	M_S ON

*Note:

In user layout RES 0 (pin 7) **MUST** be tied low for proper operation.



JP4,VR3: Address Decoder

Reference	Description	Setting		Connector
JP4	DS90UB901Q I2C Device ID Address Selection Default address: 0xB0'h	Enabled – With jumper JP4 VR1 CAD VSS	VSS – Default address (Default) JP4 VR1 CAD VSS	JP4 VR1 CAD VSS
JP4 & VR3	R _{ID} value adjustment (via screw) JP4 <u>MUST</u> have a jumper to use VR3 potentiometer. VR3 = 0Ω to 100 K Ω	Clockwise VR3 Decreases RID value	Counter- Clockwise VR3 Increases RID value	JP4 VR1 CAD VSS VR3

The ID[x] (CAD) pin is used to set the physical slave address of the DS90UB901Q (I²C only) to allow up to six devices on the bus using only a single pin. The Address Decoder employs a 10 k Ω pull up resistor to +1.8V and a variable potentiometer (VR3) for the pull down resistor R_{ID} to GND to generate six unique values based on the table below. Once the address bits are latched on power up, the device will keep the slave address until a power down or reset condition occurs.

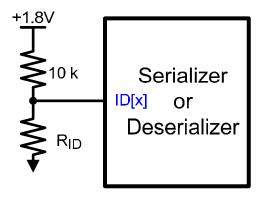


Figure 3. ID[x] Pin Connection Diagram



Table 1. ID[x] Resistor Value - DS90UB901Q Slave Address

Rid Resistor Ω	Address 7'b	Address 8'b 0 appended (WRITE)
0	7b' 101 1000 (h'58)	8b' 1011 0000 (h'B0)
2.0K	7b' 101 1001 (h'59)	8b' 1011 0010 (h'B2)
4.7K	7b' 101 1010 (h'5A)	8b' 1011 0100 (h'B4)
8.2K	7b' 101 1011 (h'5B)	8b' 1011 0110 (h'B6)
12.1K	7b' 101 1100 (h'5C)	8b' 1011 1000 (h'B8)
39.0K	7b' 101 1110 (h'5E)	8b' 1011 1100 (h'BC)

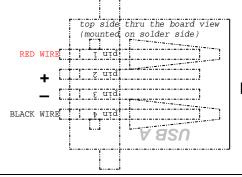
Serializer Bidirectional Control Bus (SCL, SDA) – I²C Compliant

Reference	Description	Settings	•	Connector
J6	I ² C Port	Pinout: 1 – VDD_I2C 2 – SCL 3 – SDA 4 – VSS		VDD_I2C SCL SDA VSS
JP8	I ² C Input Port	Closed: VDD_I2C power is applied through the VDDIO source with onboard 1.0Kohm pull up resistors (Default)	Open: VDD_I2C power is applied externally Note: when connecting the bus externally, the target source must have external pull up resistor.	JP8 VDDIO VDD_I2C



JP6, JP7: USB Red and Black wire

Reference	Description	VDD	VSS	OPEN
JP6	Power wire in USB cable	Red wire tied	Red wire	Red wire
	thru P3 (and P2 not	to VDD	tied to VSS	floating
	mounted) connector		(Default)	(not
	Jumper RED to VSS –		,	recommended)
	recommended	■ VDD	■ VDD	■ VDD
		JP6 RED	JP6 RED	JP6 RED
	Note: Normally VDD in USB application	● VSS	● VSS	● VSS
JP7	Power wire in USB cable	Black wire	Black wire	Black wire
	thru P3 <i>(and P2 not</i>	tied to VDD	tied to VSS	floating
	mounted) connector		(Default)	(not
	Jumper BLACK to VSS –			recommended)
	recommended	🔽 VDD	■ VDD	■ VDD
		JP7 BLK	JP7 BLK	JP7 BLK
Note: Normally VSS in USB application		● VSS	● VSS	● VSS
top side thru the board view				
(mounted on solder side)				
RED WIRE T uid				



P2

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Serializer LVCMOS and FPD-Link III Pinout by Connector

The following three tables illustrate how the Serializer connections mapped to the IDC connector J1, the FPD-Link III I/O on the USB-A connector P3, and the mini USB P2 (not mounted) pinouts. Note — labels are also printed on the demo boards for both the LVCMOS inputs/outputs and FPD-Link III I/Os.

J1			
	LVCM	OS I/O	
pin no.	name	name	pin no.
1	GND	GPIO[0]	2
3	GND	GPIO[1]	4
5	GND	DIN0	6
7	GND	DIN1	8
9	GND	DIN2	10
11	GND	DIN3	12
13	GND	DIN4	14
15	GND	DIN5	16
17	GND	DIN6	18
19	GND	DIN7	20
21	GND	DIN8	22
23	GND	DIN9	24
25	GND	DIN10	26
27	GND	DIN11	28
29	GND	DIN12	30
31	GND	DIN13	32
33	GND	HS	34
35	GND	VS	36
37	GND	PCLK	38

Р3			
(bottom side)			
FPD-Link III			
pin no. name			
1	JP6		
2	DOUT+		
3	DOUT-		
4	JP7		

P2			
(top	side)		
(not me	ounted)		
FPD-L	Link III		
pin no. name			
5	JP6		
4	NC		
3	DOUT-		
2 DOUT+			
1	JP7		

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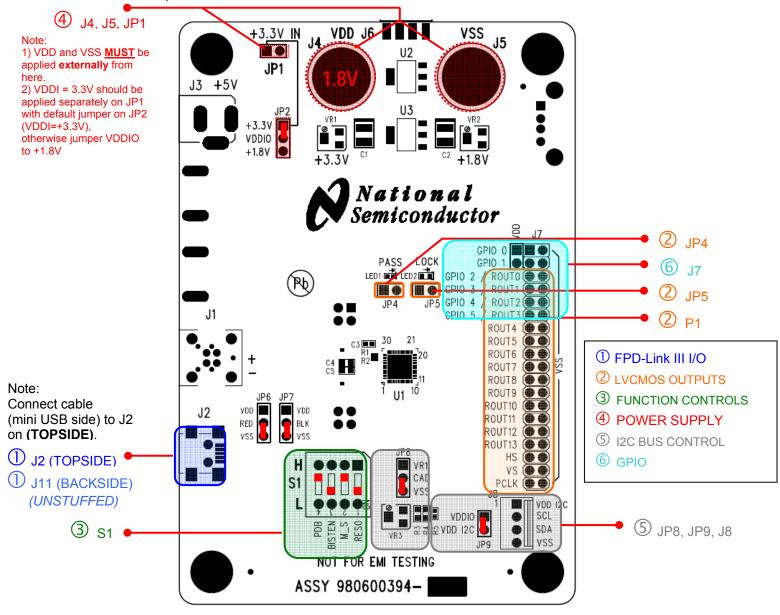


DS9UB902Q Deserializer Board Description:

The USB connector J2 (mini USB) on the topside of the board provides the interface connection for FPD-Link III signals to the Serializer board. Note: J11 (mini USB) on the bottom side is un-stuffed and not used with the cable provided in the kit.

The Deserializer board is powered externally from the J4 (VDD) and J5 (VSS) connectors shown below. For the Deserializer to be operational, the S1 switch – PDB must be set HIGH. S1-RES0, BISTEN (Normal mode) must be set LOW. Master or slave mode is user selected on S1-M S (MODE)..

The 2x17 pin IDC Connector J7 provides access to the 16 bit 1.8V or 3.3V LVCMOS and PCLK clock outputs.



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Configuration Settings for the Deserializer Demo Board

VDDIO: 1.8V or 3.3V LVCMOS INPUT/OUTPUT SELECTION

Reference	Description	+1.8V VDDIO	+3.3V VDDIO	JP2
JP2	VDDIO LVCMOS	VDDIO = 1.8V	VDDIO = 3.3V	
	I/O level configuration.		(Default)	
		3.3V VDD JP1 1.8V	JP1 JP2 1.8V	+3.3V IN J4 VDD JP1 JP2 +3.3V VDDIO +1.8V
		1.8V	apply external	
		LVCMOS	3.3V	
			LVCMOS	

S1: Deserializer Input Features Selection

Reference	Description	Input = L	Input = H	S1
PDB	PowerDown Bar	Power Down (Disabled)	Operational (Default)	U COO
BISTEN	BIST Enable Pin	Normal operating mode. BIST is disabled. (Default)	BIST Mode is enabled.	BSTEN ON CONTRACT IS
M_S (MODE)	I ² C Master / Slave select	Master	Slave (Default)	m
RES 0 (* IMPORTANT See user note below)	Reserved	MUST be tied low for normal operation (Default)		

^{*}Note: In user layout RES 0 (pin 39) MUST be tied low for proper operation.



JP8, VR3: Address Decoder

Reference	Description	Setting		Connector
JP8	DS90UB902Q I ² C Device ID Address Selection Default address: 0xC0'h	Enabled – With jumper JP8 VR1 CAD VSS	VSS – Default address (Default) JP8 VR1 CAD VSS	JP8 VR1 CAD VSS
JP8 & VR3	R _{ID} value adjustment (via screw) JP8 <u>MUST</u> have a jumper to use VR3 potentiometer. VR3 = 0Ω to 100 K Ω	Clockwise VR3 Decreases Rid value	Counter- Clockwise VR3 Increases RID value	JP8 VR1 CAD VSS VR3

The ID[x] (CAD) pin is used to set the slave address of the DS90UB902Q (I²C only) to allow up to six devices on the bus using only a single pin. The Address Decoder employs a 10 k Ω pull up resistor to VDD 1.8V and a variable potentiometer (VR3) pull down resistor R_{ID} to generate six unique values based on the table below. Once the address bits are latched on power up, the device will keep the slave address until a power down or reset condition occurs.

Table 2. ID[x] Resistor Value - DS90UB902Q Slave Address

Rid Resistor Ω	Address 7'b	Address 8'b 0 appended (WRITE)
0	7b' 110 0000 (h'60)	8b' 1100 0000 (h'C0)
2.0K	7b' 110 0001 (h'61)	8b' 1100 0010 (h'C2)
4.7K	7b' 110 0010 (h'62)	8b' 1100 0100 (h'C4)
8.2K	7b' 110 0011 (h'62)	8b' 1101 0110 (h'C6)
12.1K	7b' 110 0100 (h'62)	8b' 1101 1000 (h'C8)
39.0K	7b' 110 0110 (h'66)	8b' 1100 1100 (h'CC)



Deserializer Bidirectional Control Bus (SCL, SDA) - I2C Compliant

Reference	Description	Settings	•	Connector
J8	I2C Port	Pinout: 1 - VDD_I2C 2 - SCL 3 - SDA 4 - VSS		J8 1 VDD 12C SCL SDA VSS
JP9	I2C Input Port	Closed: VDD_I2C power is applied through the VDDIO source with onboard 1.0Kohm pull up resistors (Default)	Open: VDD_I2C power is applied externally Note: when connecting the bus externally, the target source must have external pull up resistor.	VDDIO VDD 12C JP9

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JP5: Output Lock Monitor

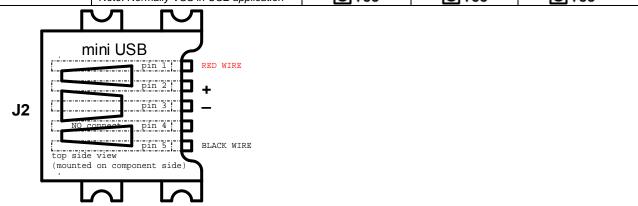
Reference	Description	Output = L	Output = H	JP5
LOCK	Receiver PLL LOCK	Unlocked	Locked	
	Note:	LOCK	L OCK	LOCK
	DO NOT SHORT	LED2	LED2	LED2
	JUMPER IN JP5.			
		JP5	JP5	JP5

JP4: Output Pass Monitor

or in output i doo monitor				
Reference	Description	Output = L	Output = H	JP4
PASS	PASS (CRC / BIST modes)	ERROR	PASS	
	Note:	PASS	PASS	PASS
	DO NOT SHORT	LED1	LED I	LED1
	JUMPER IN JP4.			
		JP4	JP4	JP4

JP6, JP7: USB Red and Black wire

Reference	Description	VDD	VSS	OPEN
JP6	Power wire in USB cable	Red wire tied	Red wire	Red wire
	thru J2 <i>(and J11 not</i>	to VDD	tied to VSS	floating
	mounted) connector		(Default)	(not
	Jumper RED to VSS –			recommended)
	recommended	🔽 VDD	■ VDD	■ VDD
		JP6 RED	JP6 RED	JP6 RED
	Note: Normally VDD in USB application	● VSS	● VSS	● VSS
JP7	Power wire in USB cable	Black wire	Black wire	Black wire
	thru J2 <i>(and J11 not</i>	tied to VDD	tied to VSS	floating
	mounted) connector		(Default)	(not
	Jumper BLACK to VSS –			recommended)
	recommended	VDD 🕎	■ VDD	■ VDD
		JP7 BLK	JP7 BLK	JP7 BLK
	Note: Normally VSS in USB application	● VSS	● VSS	● VSS





Deserializer FPD-Link III Pinout and LVCMOS by Connector

The following three tables illustrate how the Deserializer connections mapped to the IDC connector J7, the mini USB connector J2, and the mini USB connector J11 pinouts. Note – labels are also printed on the demo boards for both the FPD-Link III I/O and LVCMOS inputs/outputs.

	J7				
	LVCM	OS I/O			
pin no.	name	name	pin no.		
1	GPIO[0]	GND	2		
3	GPIO[1]	GND	4		
5	ROUT0	GND	6		
7	ROUT1	GND	8		
9	ROUT2	GND	10		
11	ROUT3	GND	12		
13	ROUT4	GND	14		
15	ROUT5	GND	16		
17	ROUT6	GND	18		
19	ROUT7	GND	20		
21	ROUT8	GND	22		
23	ROUT9	GND	24		
25	ROUT10	GND	26		
27	ROUT11	GND	28		
29	ROUT12	GND	30		
31	ROUT13	GND	32		
33	HS	GND	34		
35	VS	GND	36		
37	PCLK	GND	38		

J2 (topside) FPD-Link III	
pin no.	name
1	JP6
2	RIN+
3	RIN-
4	NC
5	JP7

J11 (bottom side) (not mounted) FPD-Link III		
pin no. name		
5	JP6	
4	NC	
3	RIN-	
2	RIN+	
1	JP7	

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Typical Connection and Test Equipment

The following is a list of typical test equipment that may be used to generate signals for the Serializer inputs:

- 1) Digital Video Source for generation of specific display timing such as CMOS imager or Graphics Controller with digital video signals (1.8V/3.3V LVCMOS).
- 2) Any other signal generator / video source that generates the correct input levels.

The following is a list of typical test equipment that may be used to monitor the output signals from the Deserializer:

- 1) Controller or capture card which supports digital video signals (1.8V/3.3V LVCMOS).
- 2) Video capture card
- 3) Microcontroller or FPGA with an I2C interface
- 4) Optional Logic Analyzer or Oscilloscope
- 5) Any SCOPE with a bandwidth of at least 50MHz for 1.8V/3.3V LVCMOS and/or 1.5GHz for observing differential signals.

Figure 4 below illustrates an application using a camera connected to DS90UB901Q with I²C bus and a MCU/FPGA controller connected to DS90UB902Q with I²C bus. Both Camera video and control information are transferred on the same serial video link.



Evaluation of the Bi-directional Control Channel

This section describes how to perform I2C instructions between MCU/FPGA and a remote peripheral device through the DS90UB902Q and DS90UB901Q pair configured in a camera type of application. Figure 4 shows the configuration of evaluation boards for I2C communication. A MCU/FPGA controller with an I2C interface is required. Refer to the DS90UB901Q/902Q datasheet for the definition of each register.

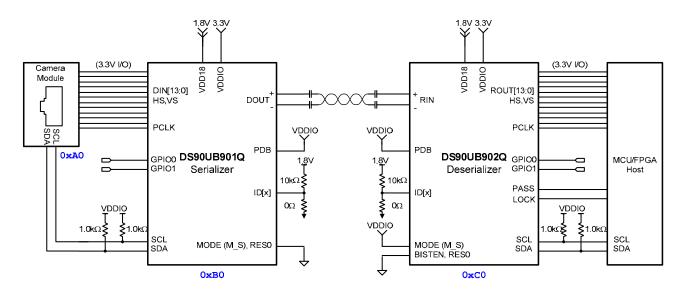


Figure 4. Example of DS90UB901Q/902Q in Camera Application

Camera Mode:

In Camera mode, I²C transactions originate from the Master controller at the Deserializer side (Figure 4). The I2C slave core in the Deserializer will detect if a transaction is intended for the Serializer or a slave at the Serializer. Commands are sent over the bidirectional control channel to initiate the transactions. The Serializer will receive the command and generate an I2C transaction on its local I2C bus. At the same time, the Serializer will capture the response on the I2C bus and return the response on the forward channel link. The Deserializer parses the response and passes the appropriate response to the Deserializer I2C bus.



Procedure - Camera Mode:

- 1) Connect the 1.8V and 3.3V power with +1.8V and +3.3V supplies accordingly. Keep the power off.
- Verify that all the jumper positions and switches are correctly set (as per default positions defined in "Configuration Settings for the Serializer/Deserializer Demo Board" tables).
- 3) Connect the USB interface cable between P3 (DS90UB901Q board) connector and J2 connector (DS90UB902Q board). Note that hot-plugging assertion of cable between Serializer and Deserializer is not supported.
- 4) Set hardware configuration for DS90UB901Q Serializer and DS90UB902Q Deserializer devices
 - a. Verify peripheral device (camera) address is set to 0xA0
 - b. Set to Camera mode: Serializer MODE (M_S) pin = L and Deserializer MODE (M_S) pin = H
 - c. Set Serializer and Deserializer I²C slave address on ID[x] (CAD) pin:
 - i. Serializer Rid=0ohm; Serializer I²C slave address is 0xB0
 - ii. Deserializer Rid=0ohm; Deserializer I²C slave address is 0xC0
- 5) Turn on the +1.8V and +3.3V power supplies
- 6) The DS90UB902Q Deserializer I²C slave is enabled to receive data directly from the I²C Master Controller. I²C transfers are processed in a one byte basis. After receiving one byte, the Deserializer slave will need to acknowledge (ACK) the transfer to receive the next following byte. The Deserializer slave holds SCL low (clock stretch) for the required period until an ACK (or NACK) is established and then releases it. The Deserializer I²C slave acknowledges all the transfers addressed to Deserializer, Serializer, or remote device.
- 7) Before initiating any I²C commands, the Deserializer needs to be programmed with the target slave device addresses and Serializer device address. SER_DEV_ID Register 0x07h sets the Serializer device address and SLAVE_x_MATCH/ SLAVE_x_INDEX registers 0x08h~0x17h set the remote target slave addresses. In slave mode the address register is compared with the address byte sent by the I²C master. If the addresses are equal to any of registers values, the I²C slave will acknowledge and hold the bus to propagate the transaction to the target device otherwise it returns no acknowledge.
- 8) Execute I²C instructions to write the following registers
 - a. Assign ID Match values for camera address on Deserializer
 - i. Write 0xA0 to Register 0x08 of Deserializer (0xC0)
 - ii. Write 0xA0 to Register 0x10 of Deserializer (0xC0)



- b. DS90UB902Q Deserializer (0xC0)
 - i. Write 0x04 to Register 0x01
 - 1. Verify that LOCK LED2 is lit; This indicates the chipset is Locked
- 9) After initialization, the camera PCLK clock and input data can begin transmission to the Serializer. The Serializer locks onto PCLK input (if present) otherwise the onchip oscillator (25 MHz) is used as the input clock source. Note the MCU controller should monitor the LOCK pin and confirm LOCK = H before performing any I2C communication across the link.

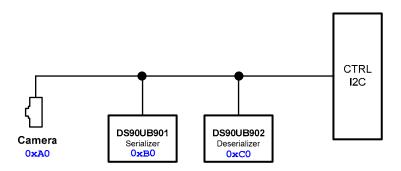


Figure 5. Virtual device addressing from MCU/FPGA I²C controller

I²C Communication over Bi-directional Control Channel in Camera Mode

This section provides instructions for a simple I²C Read/Write transaction over the bidirectional control channel validating the interface between the host and Deserializer to Serializer.

- 1) Check the Deserializer SER DEV ID register 0x07 contents
- 2) The value entered in Deserializer register 0x07 sets the target Serializer device to communicate with. Load the Serializer slave address register.
- 3) Host controller to load and transmit data byte to Serializer address 0xB0
- 4) For verification purposes Serializer register 0x13 General-purpose register will be exercised for reading and writing data. Other Serializer registers can be programmed to check internal functions; such as register 0x03 b[0] TRFB.



- 5) Host controller to load and transmit write transaction to register byte 0x13 = 0xFF. Note default of register 0x13 = 0x00.
- 6) Host controller to read back Serializer 0xB0 register 0x13 = 0xFF

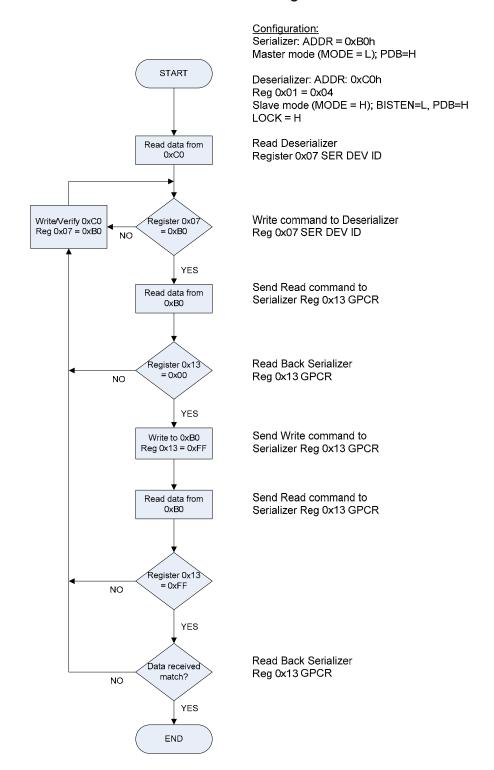


Figure 6. Bi-directional Control Channel Flowchart in Camera Mode

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Display Mode:

In Display mode, I2C transactions originate from the controller attached to the Serializer. The I2C slave core in the Serializer will detect if a transaction targets (local) registers within the Serializer or the (remote) registers within the Deserializer or a remote slave connected to the I2C master interface of the Deserializer. Commands are sent over the forward channel link to initiate the transactions. The Deserializer will receive the command and generate an I2C transaction on its local I2C bus. At the same time, the Deserializer will capture the response on the I2C bus and return the response as a command on the bidirectional control channel. The Serializer parses the response and passes the appropriate response to the Serializer I2C bus.

<u>Note:</u> The default settings for this EVK are shipped with a camera mode configuration, but this EVK also supports a display mode. This mode is suitable for setups where a host controller is connected to the DS90UB901Q Serializer end and a display module is connected to the DS90UB902Q Deserializer end. The I²C Master would need to be connected to the DS90UB901Q Serializer end. A typical setup for display mode is shown below:

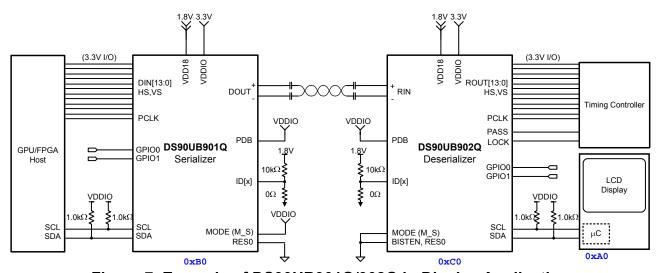
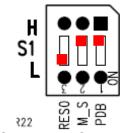


Figure 7. Example of DS90UB901Q/902Q in Display Application

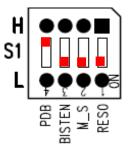


Procedure - Display Mode:

- 1) Connect the 1.8V and 3.3V power with +1.8V and +3.3V supplies accordingly. Keep the power off.
- 2) Verify that all the jumper positions and switches are correctly set. NOTE: For <u>Display Mode</u>, the default settings for switch S1-M_S on S1 for the DS90UB901Q Serializer and DS90UB902Q Deserializer boards must be reversed.



DS90UB901Q board: S1



DS90UB902Q board: S1

- 3) Connect the USB interface cable between P3 (DS90UB901Q board) connector and J2 connector (DS90UB902Q board).
- Set hardware configuration for DS90UB901Q Serializer and DS90UB902Q Deserializer devices
 - a. Peripheral device (display) address is set to 0xA0
 - b. Set to Display mode: Serializer MODE (M_S) pin = H and Deserializer MODE (M_S) pin = L
 - c. Set Serializer and Deserializer I²C slave address on ID[x] (CAD) pin:
 - i. Serializer Rid=0ohm; Serializer I2C slave address is 0xB0
 - ii. Deserializer Rid=0ohm; Deserializer I2C slave address is 0xC0
- 5) Turn on the +1.8V and +3.3V power supplies
- 6) Before initiating any I²C commands, the Serializer needs to be programmed with the target slave device address and Deserializer device address. DES_DEV_ID Register 0x06h sets the Deserializer device address and SLAVE_DEV_ID register 0x7h sets the remote target slave address. If the I²C slave address matches any of registers values, the I²C slave will hold the transaction allowing read or write to target device. Note: In Display mode operation, registers 0x08h~0x17h on Deserializer must be reset to 0x00.
- 7) Execute I2C instructions to write the following registers
 - a. DS90UB901Q Serializer (0xB0)
 - b. Set target slave device address on the Serializer
 - i. Write 0xA0 to Register 0x07 of Serializer (0xB0)



- Verify that LOCK LED2 is lit; This indicates the chipset is Locked
- 8) After initialization, the PCLK clock and input data can begin transmission to the Serializer. The Serializer locks onto PCLK input (if present) otherwise the on-chip oscillator (25 MHz) is used as the input clock source. Note the user should monitor the LOCK pin and confirm LOCK = H before performing any I2C communication across the link.

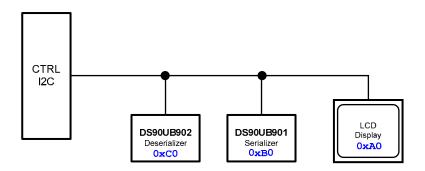


Figure 8. Virtual device addressing from GPU/FPGA I2C controller

I²C Communication over Bi-directional Control Channel in Display Mode

This section provides instructions for a simple I²C Read/Write transaction over the bidirectional control channel validating the interface between the host and Serializer to Deserializer.

- 1) Check the Serializer DES DEV ID register 0x06 contents
- 2) The value entered in Serializer register 0x06 sets the target Deserializer device to communicate with. Load the Deserializer slave address register.
- 3) Host controller to load and transmit data byte to Deserializer address 0xC0
- 4) For verification purposes Deserializer register 0x13 General-purpose register will be exercised for reading and writing data. Other Deserializer registers can be programmed to check internal functions; such as register 0x03 b[0] RRFB.
- 5) Host controller to load and transmit write transaction to register byte 0x13 = 0xFF. Note default of register 0x13 = 0x00.



6) Host controller to read back Deserializer 0xC0 register 0x13 = 0xFF

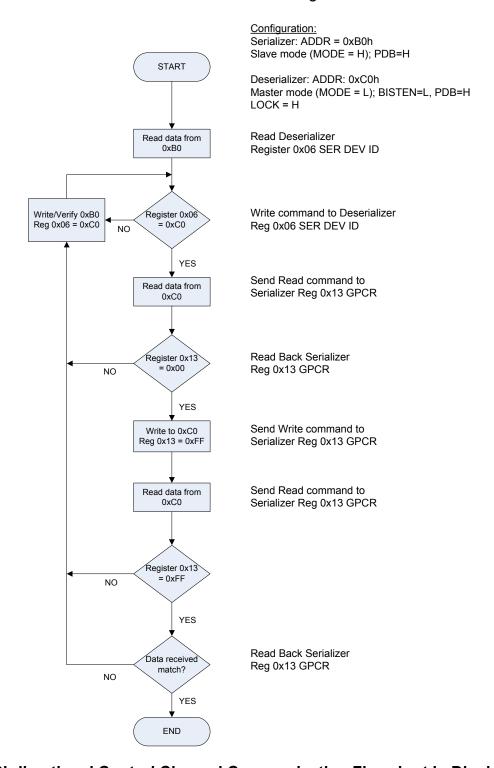


Figure 9. Bi-directional Control Channel Communication Flowchart in Display Mode

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Troubleshooting Demo Setup

NOTE: The DS9UB901Q and DS9UB902Q are NOT USB compliant and should not be plugged into a USB device nor should a USB device be plugged into the demo boards.

If the demo boards are not performing properly, use the following as a guide for quick solutions to potential problems. If the problem persists, please contact the local Sales Representative for assistance.

QUICK CHECKS:

- 1. Check that Powers and Grounds are connected to both Serializer and Deserializer boards.
- Check the supply voltage (typical 1.8V) and also current draw with both Serializer and Deserializer boards. The Serializer board should draw about 70mA with clock and all data bits switching at 43 MHz. The Deserializer board should draw about 100mA with clock and all data bits switching at 43 MHz.
- 3. Verify input clock and input data signals meet requirements (VIL, VIH, tset, thold), Also verify that data is strobed on the selected rising/falling (RFB register) edge of the clock.
- 4. Check that the Jumpers and Switches are set correctly.
- 5. Check that the cable is properly connected.

TROUBLESHOOTING CHART

Problem	Solution
There is only the output clock.	Make sure the data is applied to the correct input pin.
There is no output data.	Make sure data is valid at the input.
No output data and clock.	Make sure Power is on. Input data and clock are active and connected correctly.
	Make sure that the cable is secured to both demo boards.
Power, ground, input data and input clock are connected correctly, but no outputs.	Check the Power Down pins of both Serializer and Deserializer boards to make sure that the devices are enabled (PDB=Vdd) for operation.
The devices are pulling more than 1A of current.	Check for shorts in the cables connecting the Serializer and Deserializer boards.
After powering up the demo boards, the power supply reads less than 1.8V when it is set to 1.8V.	Use a larger power supply that will provide enough current for the demo boards, a 500mA minimum power supply is recommended.



Note: Please note that the following references are supplied only as a courtesy to our valued customers. It is not intended to be an endorsement of any particular equipment or supplier.

Cable References

The FPD-Link III interface cable included in the kit is a standard off-the-shelf high-speed USB 2.0 with a 4-pin USB A type on one end and a 5-pin mini USB on the other end and is included for demonstration purposes only.

NOTE: The DS9UB901Q and DS9UB902Q are NOT USB compliant and should not be plugged into a USB device nor should a USB device be plugged into the demo boards.

The inclusion of the USB cable in the kit is for:

- 1) Demonstrating the robustness of the FPD-Link III link over standard twisted pair data cables.
- 2) Readily available and in different lengths without having custom cables made.
- For optimal performance, we recommend Shielded Twisted Pair (STP) 100ohm differential impedance and 24 AWG (or larger diameter) cable for high-speed data applications.

Leoni Dacar 538 series cable:

www.leoni-automotive-cables.com

Rosenberger HSD connector:

www.rosenberger.de/en/Products/35 Automotive HSD.php

Equipment References

Corelis CAS-1000-I2C/E I2C Bus Analyzer and Exerciser Products:

www.corelis.com/products/I2C-Analyzer.htm

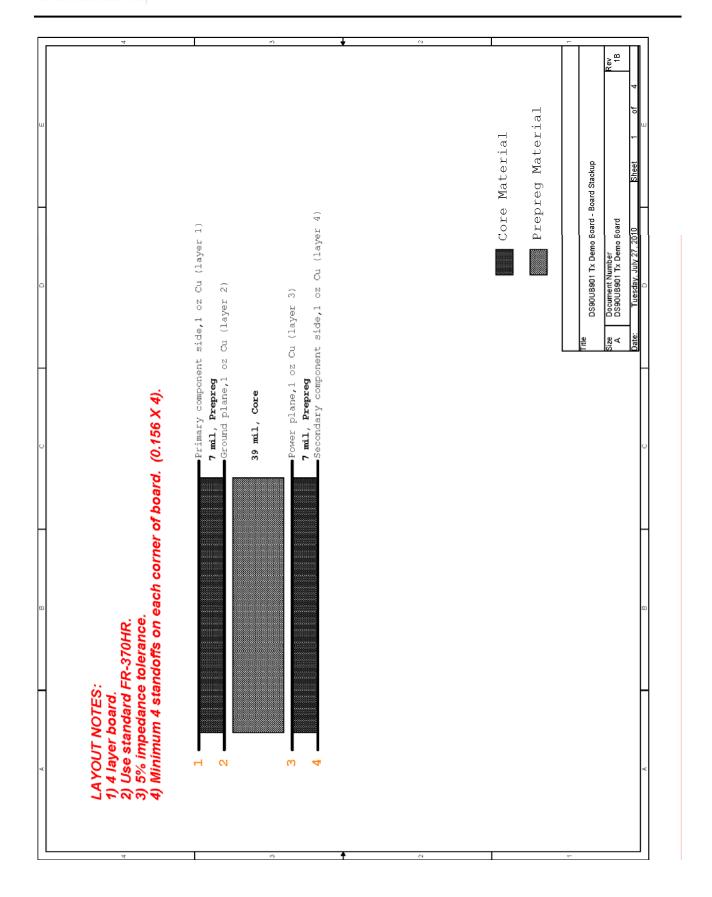


Appendix

Serializer and Deserializer Demo PCB Schematics:

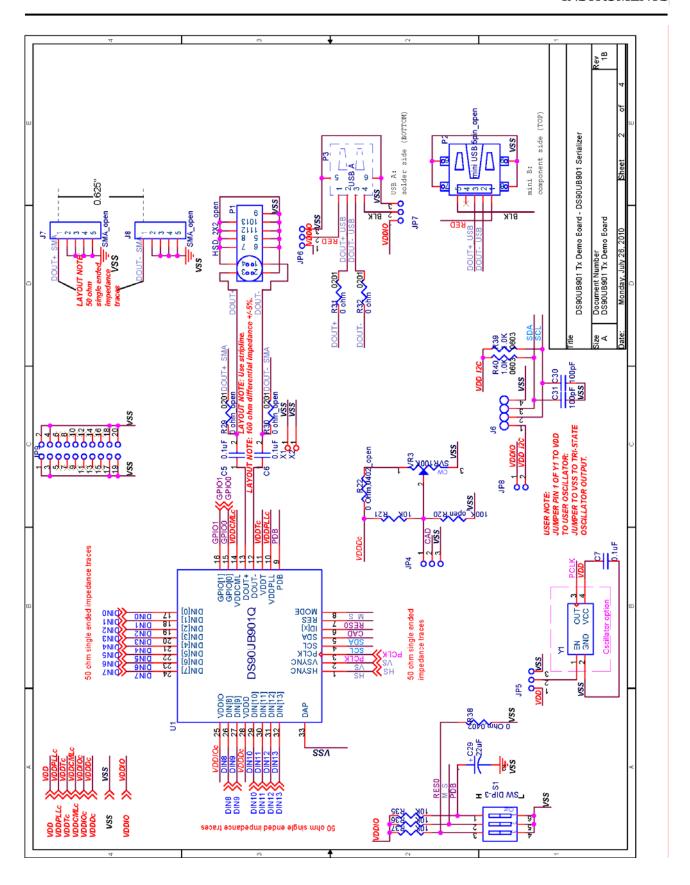
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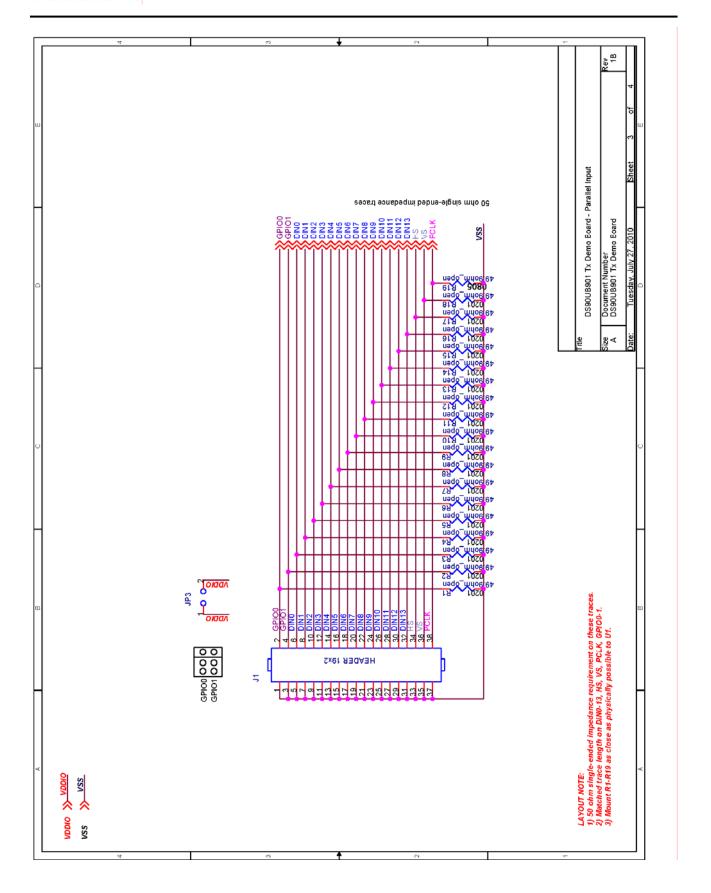
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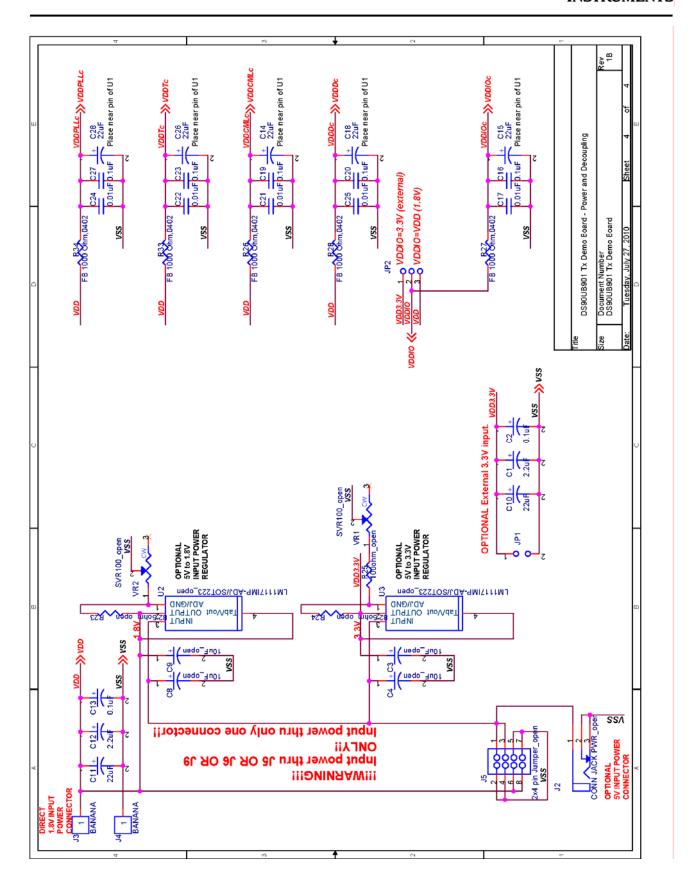
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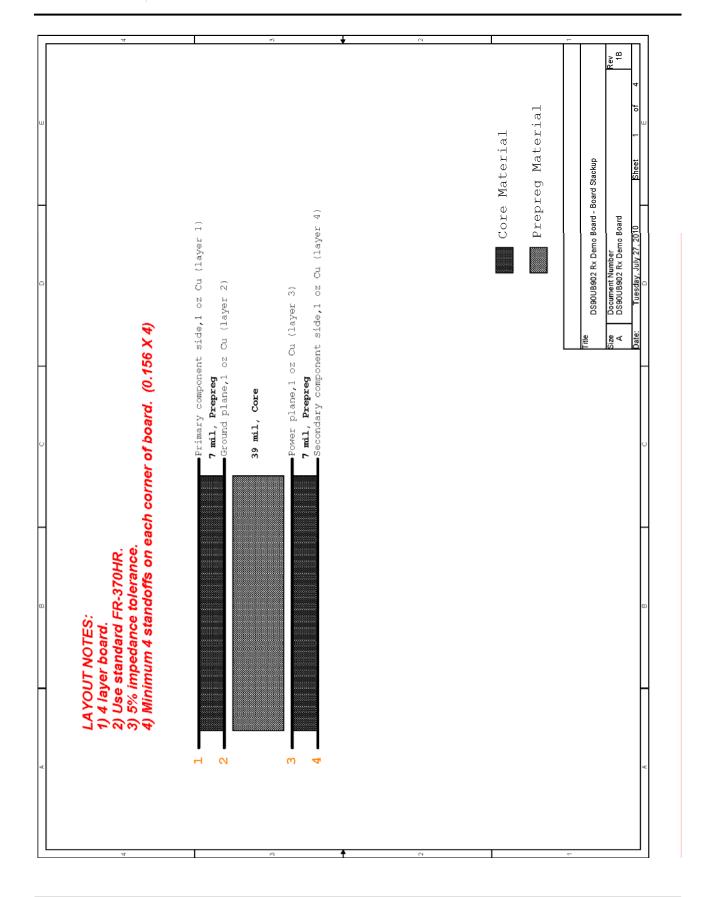




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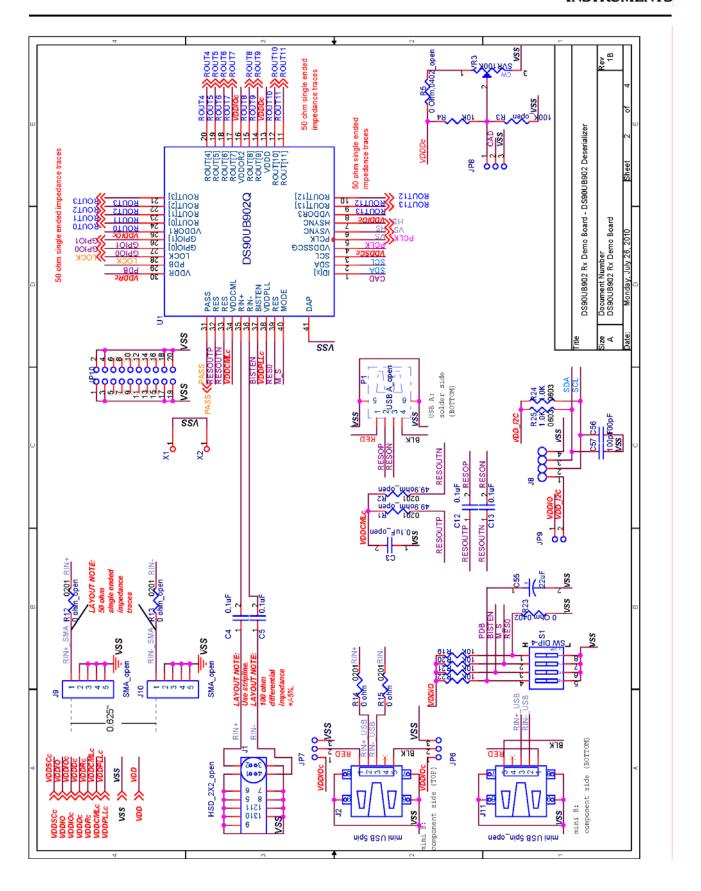
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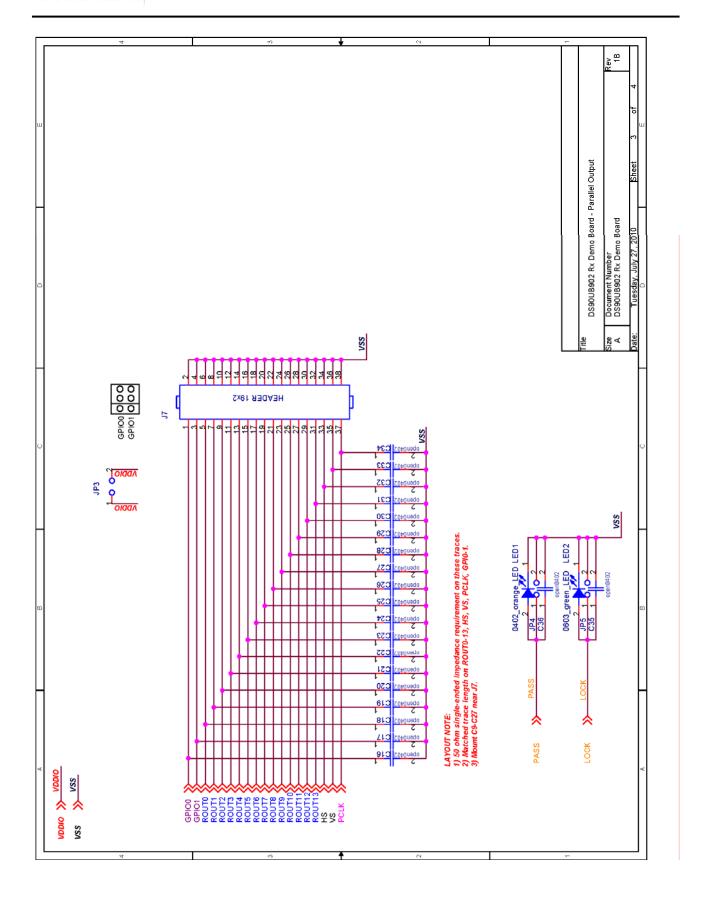
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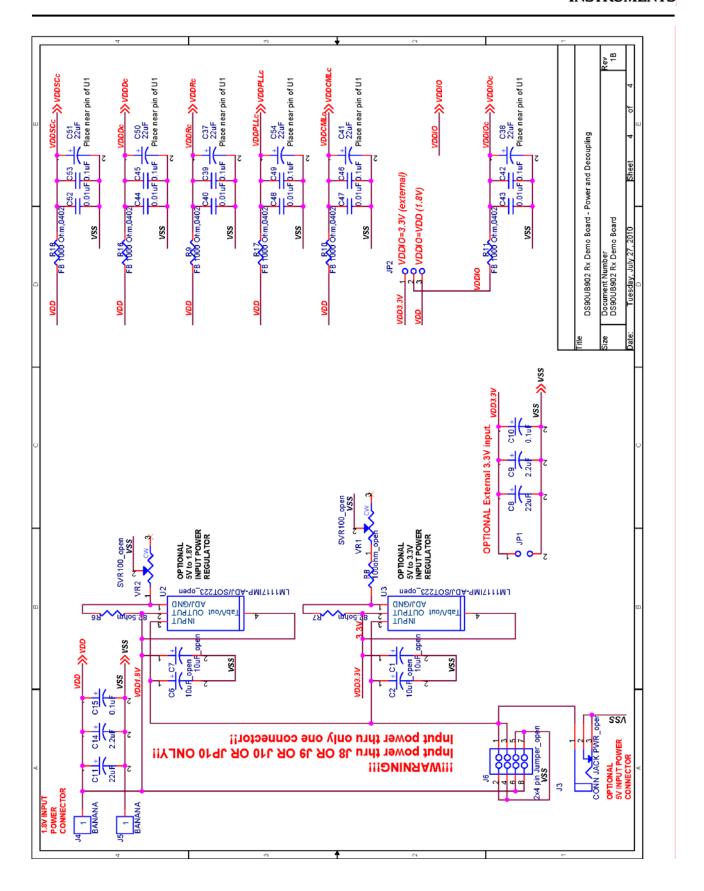


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BOM (Bill of Materials) Serializer Demo PCB:

 ${\sf DS90UB901\ Tx\ Demo\ Board\ -Board\ Stackup\ Revised:\ Tuesday,\ July\ 27,\ 2010}$

DS90UB901 Tx Demo Board Revision: 1B

Bill Of Materials

Item	Quanti	ty	Reference	Part	PCB Footprint
	1	2	C1,C12	2.2uF	3528-21_EIA
:	2	2	C13,C2	0.1uF	CAP/HDC-1206
;	3	4	C3,C4,C8,C9	10uF_open	CAP/B
	4	2	C5,C6	0.1uF	CAP/HDC-0603
	5	6	C7,C16,C19,C20,C23,C27	0.1uF	CAP/HDC-0603
	6		C10,C11	22uF	CAP/N
	7	6	C14,C15,C18,C26,C28,C29	22uF	CAP/EIA-B 3528-21
	8	5	C17,C21,C22,C24,C25	0.01uF	CAP/HDC-0603
9	9	2	C30,C31	100pF	CAP/HDC-0201
10	0	3 .	JP1,JP3,JP8	2-Pin Header	Header/2P
1	1	5 .	JP2,JP4,JP5,JP6,JP7	3-Pin Header	Header/3P
13	2	1.	JP9	2X10-Pin Header, open	Header/2X10P
1:	3	1,	J1	HEADER 19x2	2x19 0.1"
1-	4	1.	J2	CONN JACK PWR_open	3-terminal thru hole power jack
1:	5	2 .	J3,J4	BANANA	CON/BANANA-S
10	6	1.	J5	2x4 pin Jumper_open	IDC_2x4
1	7	1,	J6	IDC1X4	IDC-1x4
18	8	2 .	J8,J7	SMA_open	Edge mount
19	9	1	P1	HSD_2X2_open	CON/HSD-4P
2	0	1	P2	mini USB 5pin_open	mini_B_USB_surface_mount
2	1	1	P3	USB A	USB_TYPE_A_4P
2:	2	ı	R1,R2,R3,R4,R5,R6,R7,R8, R9,R10,R11,R12,R13,R14,	49.9ohm_open	RES/HDC-0201
			R15,R16,R17,R18		
2			R19	49.9ohm_open	RES/HDC-0805
2			R20	100K_open	RES/HDC-0603
2			R21,R35,R36,R37	10K	RES/HDC-0603
2			R22	0 Ohm,0402_open	RES/HDC-0402
2	7	2	R24,R23	82.5ohm_open	RES/HDC-0603
2			R25	100ohm_open	RES/HDC-0603
2			R26	FB 1000 Ohm,0402	RES/HDC-0402
3			R27,R28,R33,R34	FB 1000 Ohm,0402	RES/HDC-0402
3			R29,R30	0 ohm_open	RES/HDC-0201
3			R31	0 ohm	RES/HDC-0201
3			R32	0 ohm	RES/HDC-0201
3	4	1	R38	0 Ohm,0402	RES/HDC-0402
3			R40,R39	1.0K	RES/HDC-0603
3			S1	SW DIP-3	DIP-3
3	7	1	U1	DS90UB901Q	32ld LLP
3		2	U2,U3	LM1117IMP-ADJ/SOT223_open	SOT223
3	9	2 '	VR1,VR2	SVR100_open	Surface Mount
4	0	1 '	VR3	SVR100K	Surface Mount
4	1	2	X2,X1	TP_0402	TP/0402
4:	2	1 `	Y1	OSC4/SM	4 PIN SMT



BOM (Bill of Materials) Deserializer Demo PCB:

DS90UB902 Rx Demo Board - Board Stackup Revised: Tuesday, July 27, 2010

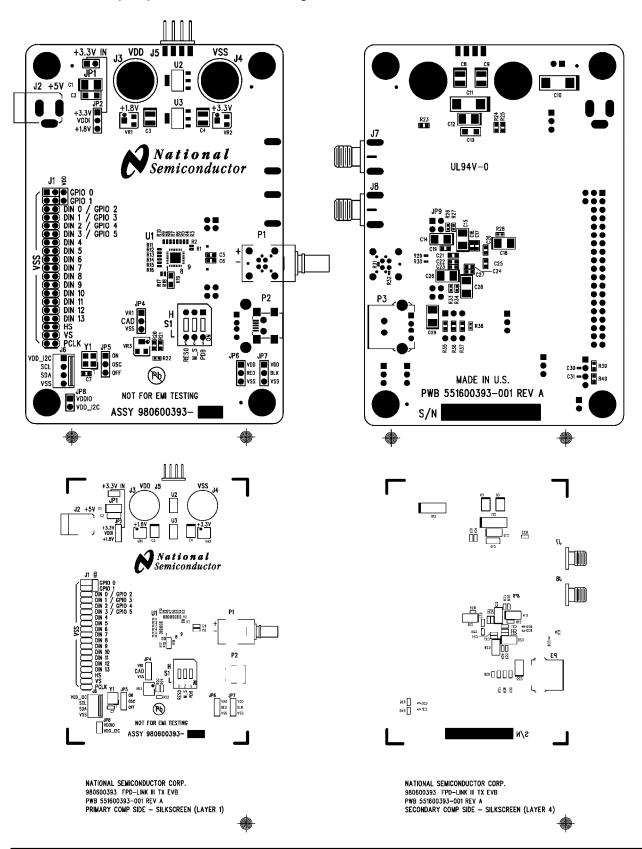
DS90UB902 Rx Demo Board Revision: 1B

Bill Of Materials

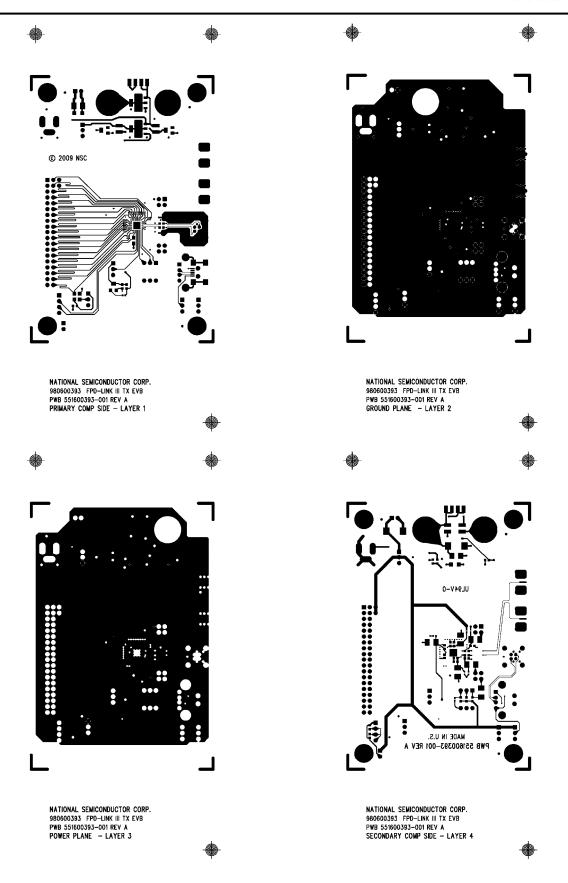
Item	Quantity Reference	Part	PCB Footprint
1		10uF_open	CAP/B
2	2 1 C3	0.1uF_open	CAP/HDC-0402
3	4 C4,C5,C12,C13	0.1uF	CAP/HDC-0603
4	2 C8,C11	22uF	CAP/N
5	5 2 C9,C14	2.2uF	3528-21_EIA
6		0.1uF	CAP/HDC-1206
7	7 21 C16,C17,C18,C19,C20,C21, C22,C23,C24,C25,C26,C27, C28,C29,C30,C31,C32,C33, C34,C35,C36		CAP/HDC-0402
8	7 C37,C38,C41,C50,C51,C54, C55	22uF	CAP/EIA-B 3528-21
ç	6 C39,C42,C45,C46,C49,C53	0.1uF	CAP/HDC-0603
10	6 C40,C43,C44,C47,C48,C52	0.01uF	CAP/HDC-0603
11		100pF	CAP/HDC-0201
12		2-Pin Header	Header/2P
13		3-Pin Header	Header/3P
14	2 JP5,JP4	2-Pin Header_open	Header/2P
15		2X10-Pin Header, open	Header/2X10P
16	6 1 J1	HSD_2X2_open	CON/HSD-4P
17	' 1 J2	mini USB 5pin	mini_B_USB_surface_mount
18	3 1 J3	CONN JACK PWR_open	3-terminal thru hole power jack
19		BANANA	CON/BANANA-S
20	•	2x4 pin Jumper_open	IDC_2x4
21	1 J7	HEADER 19x2	2x19 0.1"
22	2 1 J8	IDC1X4	IDC-1x4
23		SMA_open	Edge mount
24	•	mini USB 5pin_open	mini_B_USB_surface_mount
25		0402_orange_LED	402
26		0603_green_LED	0603 (Super Thin)
27		USB A_open	USB_TYPE_A_4P
28		49.9ohm_open	RES/HDC-0201
29	,	100K_open	RES/HDC-0603
30		10K	RES/HDC-0603
31		0 Ohm,0402_open	RES/HDC-0402
32		82.5ohm	RES/HDC-0603
33	•	100ohm_open	RES/HDC-0603
34		FB 1000 Ohm,0402	RES/HDC-0402
35		0 ohm_open	RES/HDC-0201
36		0 ohm	RES/HDC-0201
37		0 Ohm,0402	RES/HDC-0402
38		1.0K	RES/HDC-0603
39	•	SW DIP-4	DIP-4
40		DS90UB902Q	40ld LLP
41		LM1117IMP-ADJ/SOT223 open	SOT223
42	,	SVR100 open	Surface Mount
42	· · · · · · · · · · · · · · · · · · ·	<u> </u>	
		SVR100K	Surface Mount TP/0402
44	2 X2,X1	TP_0402	17/0402



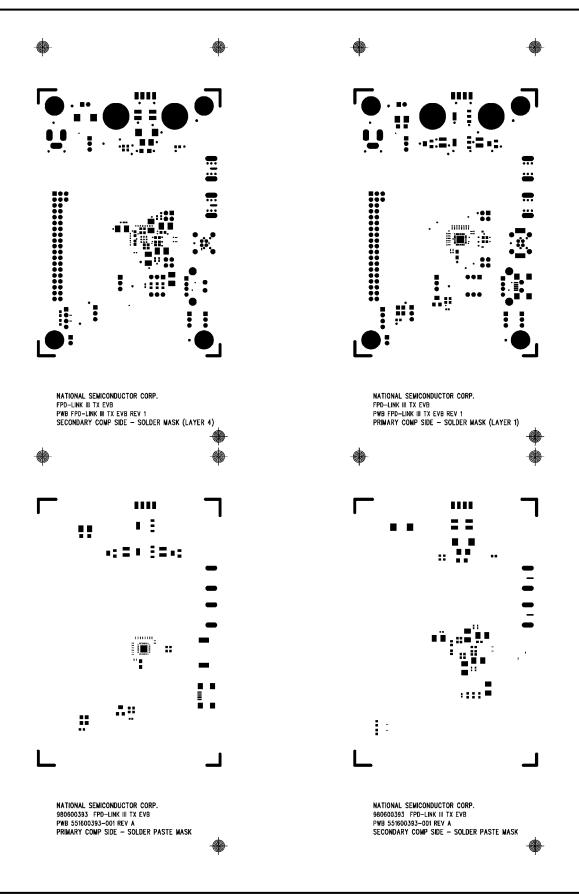
Serializer (Tx) Demo PCB Layout:





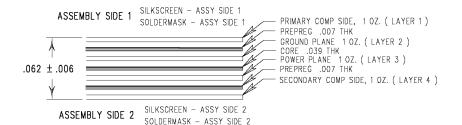




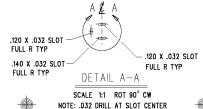




Serializer (Tx) Demo PCB Stackup:



	HOLE CHART				
CODE	SIZE	QTY	PLATED	TOL	
+	0.006	30	YES	± .003	
×	0.010	18	YES	± .003	
	0.016	41	YES	± .003	
\Diamond	0.035	10	YES	± .003	
X	0.040	58	YES	± .003	
\bowtie	0.043	19	YES	± .003	
Α	0.065	4	YES	± .003	
В	0.091	2	YES	± .003	
С	0.156	4	YES	± .004	
D	0.265	2	YES	± .005	
E	0.032	3	YES	± .003	



NOTE: .032 DRILL AT SLOT CENTER PER NC DRILL FILE .12 R TYP XX П 11111 PPP P واوال 4.500 + 0 XXX 0.000 +c X -.250 0.000 NATIONAL SEMICONDUCTOR CORP. 980600393 FPD-LINK III TX EVB PWB 551600393-001 REV A DRILL DRAWING

3.050

-.250

44

NOTES: UNLESS OTHERWISE SPECIFIED

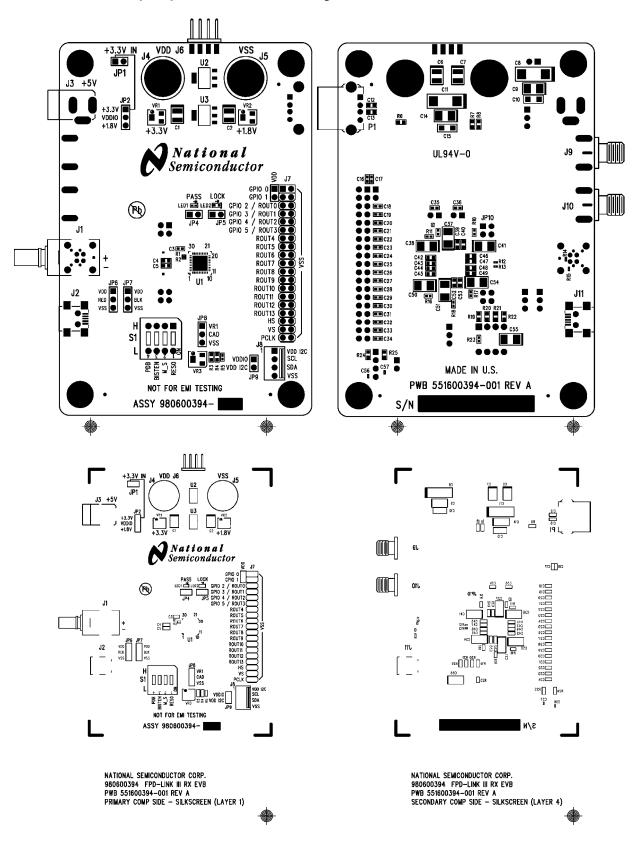
THRU HOLE SLOT - SEE DETAIL A-A

- 1. PRIMARY COMPONENT SIDE IS SHOWN.
- 2. DELETED.
- FABRICATE USING MASTER FILM PWB 551600393-001 REV A. USE GERBER FILE A673BOA.PHO FOR BOARD ROUTE.
- ACCEPTABILITY SHALL BE BASED ON IPC-A-600, CLASS 2
- MATERIAL: BASE MATERIAL IS FR-370HR OR EQUIVALENT, COLOR GREEN, 0.062 INCH NOM. THICKNESS. COPPER CLADDING SHALL BE 1 OZ.
- 6. PLATING: ALL HOLES AND CONDUCTIVE SURFACES SHALL BE PLATED WITH A MIN. OF .001 INCH COPPER. EXPOSED PADS / TRACES SHALL BE PLATED .000030 MIN GOLD OVER NICKEL, .000150 MIN.
- 7. FABRICATION TOLERANCES:
 - END PRODUCT CONDUCTOR WIDTHS AND LAND DIAMETERS SHALL NOT VARY MORE THAN .002 INCH FROM THE 1:1 DIMENSIONS OF THE MASTER PATTERN. THE CONDUCTIVE PATTERN SHALL BE POSITIONED SO THAT THE LOCATION OF ANY LAND SHALL BE WITHIN .010 INCH DIAMETER TO THE TRUE POSITION OF THE HOLE IT CIRCUMSCRIBES THE MINIMUM ANNULAR RING SHALL BE .002 INCH. BOW AND TWIST SHALL NOT EXCEED .010 INCH PER INCH.
- SOLDERMASK BOTH SIDES PER IPC-SM-840, TYPE A, CLASS B. COLOR-GREEN. THERE SHALL BE NO SOLDERMASK ON ANY LAND.
- SILKSCREEN THE LEGEND ON BOTH SIDES USING NON CONDUCTIVE EPOXY INK. COLOR-WHITE. THERE SHALL BE NO INK ON ANY LAND.
- 10. THE .00975 TRACES (LAYER 1) TO BE 50 OHM SINGLE ENDED IMPEDANCE AND THE DIELECTRIC REFERENCED IN BOARD STACK DETAIL IS SUGESTED. HOWEVER, TRACE WIDTHS AND OR DIELECTRIC THICKNESS MAY BE MICRO-MODIFIED IN ORDER TO FABRICATE BOARDS TO THE REQUIRED IMPEDANCE NOMINALS TO A TOLERANCE OF +/- 10%.
- 11. PCB MUST BE MADE OF US RECOGNIZED MATERIAL AND TRACEABLE FOR 94V-0 MINIMUM FLAMMABILITY RATING AND MANUFACTURED BY A UL RECOGNIZED PRINTED CIRCUIT BOARD SUPPLIER. PCB MUST BE PERMANENTLY MARKED WITH UL RECOGNIZED MANUFACTURER'S LOGO AND TYPE CODE AS DESIGNATED IN THE UL RECOGNIZED DIRECTORY.

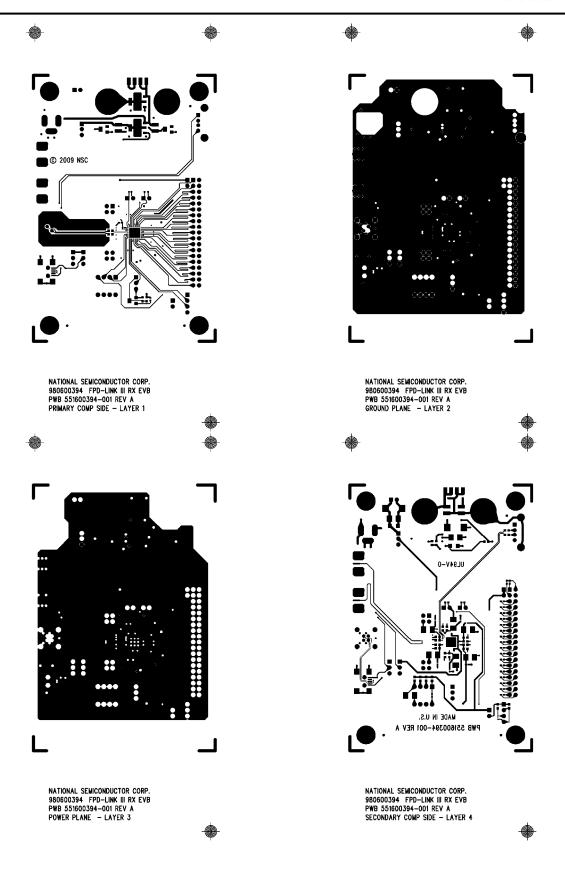
SERDESUB-16USB User's Guide SNLU100 - April 2012



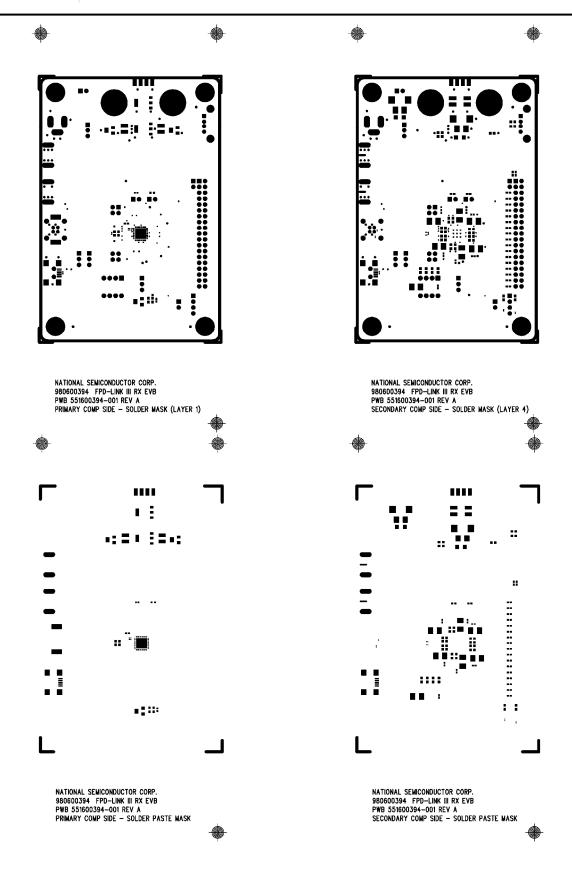
Deserializer (Rx) Demo PCB Layout:





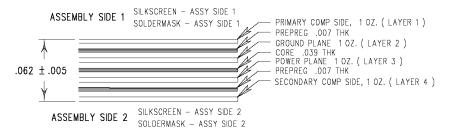




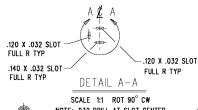




Deserializer (Rx) Demo PCB Stackup:



HOLE CHART				
CODE	SIZE	QTY	PLATED	TOL
+	0.006	28	YES	± .003
×	0.010	20	YES	± .003
	0.016	46	YES	± .003
\Diamond	0.035	10	YES	± .003
X	0.040	76	YES	± .003
\bowtie	0.043	4	YES	± .003
Α	0.065	4	YES	± .003
В	0.091	2	YES	± .003
С	0.156	4	YES	± .003
D	0.265	2	YES	± .004
E	0.032	3	YES	± .005



THRU HOLE SLOT - SEE DETAIL A-A

	.140 X .032 SLOT	120 X FULL I	.032 SLOT R TYP
.12 R TYP —	NOTE: .03	LE 1:1 ROT 90°CW 32 DRILL AT SLOT CENTEI R NC DRILL FILE	R
4 PLCS			
	+¢ xx	ф ф	± _B
	Z A F F X		□ ***

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XXXX

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NATIONAL SEMICONDUCTOR CORP.

980600394 FPD-LINK III RX EVB

3.050

PWB 551600394-001 REV A

0.000

DRILL DRAWING

4.500

-.250

48

0.000

-.250

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. PRIMARY COMPONENT SIDE IS SHOWN.
- 2 DELETED
- 3. FABRICATE USING MASTER FILM PWB 551600394-001 REV A. USE GERBER FILE A674BOA.PHO FOR BOARD ROUTE.
- ACCEPTABILITY SHALL BE BASED ON IPC-A-600, CLASS 2
- MATERIAL: BASE MATERIAL IS FR-370HR OR EQUIVALENT, COLOR GREEN, 0.062 INCH NOM. THICKNESS. COPPER CLADDING SHALL BE 1 OZ.
- 6. PLATING: ALL HOLES AND CONDUCTIVE SURFACES SHALL BE PLATED WITH A MIN. OF .001 INCH COPPER. EXPOSED PADS / TRACES SHALL BE PLATED .000030 MIN GOLD OVER NICKEL, .000150 MIN.
- 7. FABRICATION TOLERANCES:

END PRODUCT CONDUCTOR WIDTHS AND LAND DIAMETERS SHALL NOT VARY MORE THAN .002 INCH FROM THE 1:1 DIMENSIONS OF THE MASTER PATTERN. THE CONDUCTIVE PATTERN SHALL BE POSITIONED SO THAT THE LOCATION OF ANY LAND SHALL BE WITHIN .010 INCH DIAMETER TO THE TRUE POSITION OF THE HOLE IT CIRCUMSCRIBES THE MINIMUM ANNULAR RING SHALL BE .002 INCH. BOW AND TWIST SHALL NOT EXCEED .010 INCH PER INCH.

- 8. SOLDERMASK BOTH SIDES PER IPC-SM-840, TYPE A, CLASS B. COLOR-GREEN. THERE SHALL BE NO SOLDERMASK ON ANY LAND.
- 9. SILKSCREEN THE LEGEND ON BOTH SIDES USING NON CONDUCTIVE EPOXY INK, COLOR-WHITE. THERE SHALL BE NO INK ON ANY LAND.
- HOWEVER, TRACE WIDTHS AND OR DIELECTRIC THICKNESS MAY BE MICRO-MODIFIED IN ORDER TO FABRICATE BOARDS TO THE
- PCB MUST BE MADE OF US RECOGNIZED MATERIAL AND TRACEABLE FOR 94V-0 MINIMUM FLAMMABILITY RATING AND MANUFACTURED BY A UL RECOGNIZED PRINTED CIRCUIT BOARD SUPPLIER, PCB MUST BE PERMANENTLY MARKED WITH UL RECOGNIZED MANUFACTURER'S LOGO AND TYPE CODE AS

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During normal operation, some circuit components may have case temperatures greater than 85° C. The EVM is designed to operate properly with certain components above 60° C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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